

17607 U.S. PTO  
00/60/603

Atty. Dkt. No. 039153-0675  
(AMD 1379)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Qi XIANG et al.

Title: SILICON ON INSULATOR  
SUBSTRATE HAVING  
IMPROVED THERMAL  
CONDUCTIVITY AND METHOD  
OF ITS FORMATION

Appl. No.: Unknown

Filing Date: Concurrently herewith

Examiner: Unknown

Art Unit: Unknown

CERTIFICATE OF EXPRESS MAILING	
I hereby certify that this correspondence is being deposited with the United States Postal Service's "Express Mail Post Office To Addressee" service under 37 C.F.R. § 1.10 on the date indicated below and is addressed to: Commissioner for Patents, PO Box 1450, Alexandria, Virginia 22313-1450.	
EV 060046781 US (Express Mail Label Number)	September 9, 2003 (Date of Deposit)
Mayra Mangandi (Printed Name)	
	
(Signature)	

21906 U.S. PTO  
10/658668  
09/09/03

**UTILITY PATENT APPLICATION**  
**TRANSMITTAL**

Mail Stop PATENT APPLICATION  
Commissioner for Patents  
PO Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Transmitted herewith for filing under 37 C.F.R. § 1.53(b) is the nonprovisional utility patent application of:

Qi XIANG  
1119 Thames Dr.  
San Jose, California 95129

Jung-Suk GOO  
100 Escondido Vill. #D  
Stanford, California 94305

James N. PAN  
3625 Peterson Wy.  
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Santa Clara, California 95051

[ ] Applicant claims small entity status under 37 CFR 1.27.

Enclosed are:

- [ X ] Specification, Claim(s), and Abstract (19 pages).
- [ X ] Formal drawings (12 sheets, Figures 1, 2, 3a, 3b, 3c, 4a, 4b, 4c, 4d, 5, 6a, 6b, 6c, 6d, 6e, 6f, 6g, 6h, 6i, 6j, 7, 8, 9, 10).
- [ X ] Declaration and Power of Attorney (4 pages).
- [ X ] Assignment of the invention to Advanced Micro Devices, Inc..
- [ X ] Assignment Recordation Cover Sheet.
- [ X ] Check in the amount of \$40.00 for Assignment recordation.
- [ ] Small Entity statement.
- [ X ] Request for application not to be published with certification under 35 USC 122(b)(2)(B)(i).
- [ ] Information Disclosure Statement.
- [ ] Form PTO/SB/08 with copies of \_\_\_ listed reference(s).
- [ X ] Application Data Sheet (37 CFR 1.76).
- [ ] Claim for Convention Priority.

The filing fee is calculated below:

Claims as Filed	Included in Basic Fee	Extra Claims	Rate	Fee Totals
Basic Fee			\$750.00	\$750.00
Total Claims: <u>32</u>	- <u>20</u>	= <u>12</u>	x \$18.00	= <u>\$216.00</u>
Independents <u>5</u>	- <u>3</u>	= <u>2</u>	x \$84.00	= <u>\$168.00</u>
⋮				
If any Multiple Dependent Claim(s) present:		+ \$280.00	=	\$0.00
		SUBTOTAL:	=	<u>\$1134.00</u>
[ ]	Small Entity Fees Apply (subtract ½ of above):		=	\$0.00
		TOTAL FILING FEE:	=	<u>\$1,134.00</u>

- [ X ] A check in the amount of \$1,134.00 to cover the filing fee is enclosed.
- [ ] The required filing fees are not enclosed but will be submitted in response to the Notice to File Missing Parts of Application.
- [ X ] The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 C.F.R. §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 50-0872. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 50-0872.

Please direct all correspondence to the undersigned attorney or agent at the address indicated below.

Respectfully submitted,

By Ronald Coslick

Date: September 9, 2003

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Customer Number: 23392  
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Facsimile: (310) 557-8475

Ronald Coslick  
Attorney for Applicant  
Registration No. 36,489

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**REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)**

Commissioner for Patents  
PO Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Applicants hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

Applicants hereby request that the attached application not be published under 35 U.S.C. 122(b).

Respectfully submitted,

Date: September 9, 2003

By Ronald Coslick

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